

(V) Final Specifications

Module	10.1" SD+ 16:9 Color TFT-LCD
Model Name	B101EW02 V0
Note (🗭)	LED Backlight with driving circuit design

Customer	Date	Approved by	Date
<u>AII</u>	<u>4/21/2009</u>		4/21/2009
Checked & Approved by	Date	Prepared by	
			4/21/2009
Note: This Specification is s notice.	ubject to change without	NBBU Marketing AU Optronics o	



Contents

1. Handling Precautions	4
2. General Description	5
2.1 General Specification	5
2.2 Optical Characteristics	6
3. Functional Block Diagram	11
4. Absolute Maximum Ratings	12
4.1 Absolute Ratings of TFT LCD Module	12
4.2 Absolute Ratings of Environment	12
5. Electrical characteristics	13
5.1 TFT LCD Module	13
5.2 Backlight Unit	15
6. Signal Characteristic	16
6.1 Pixel Format Image	16
6.2 The input data format	17
6.3 Signal Description/Pin Assignment	18
6.4 Interface Timing	20
6.5 Power Sequence	21
6.5.1 Panel Power Sequence	21
7. Panel Reliability Test	22
7.1 Vibration Test	22
7.2 Shock Test	22
7.3 Reliability Test	22
8. Mechanical Characteristics	23
8.1 LCM Outline Dimension	23
9. Shipping and Package	25
9.1 Shipping Label Format	25
9.2 Carton package	26
9.3 Shipping package of palletizing sequence	26
10. Appendix: FDID description	27



Record of Revision

Version and Date	Page	Old description	New Description	Remark
0.1 2008/10/29	All	First Edition for Customer		
0.2 2009/1/14	5	Power consumption (typ)	Power consumption (max)	
0.2 2009/1/14	5,6	White Luminance 180nit typ.	White Luminance 200nit typ.	
0.3 2009/1/20	32	EDID TBD	Update EDID	
0.4 2009/2/23	6		Update Response Time and Color / Chromaticity Coodinates	
0.4 2009/2/23	30		Add HW code control table	
0.4 2009/2/23	28~29		Update 2D Drawing (change connector position)	
1.0 2009/4/21		Final Edition for Customer		



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1. Handling Precautions

- 1) Since front polarizer is easily damaged, pay attention not to scratch it.
- 2) Be sure to turn off power supply when inserting or disconnecting from input connector.
- 3) Wipe off water drop immediately. Long contact with water may cause discoloration or spots.
- 4) When the panel surface is soiled, wipe it with absorbent cotton or other soft cloth.
- 5) Since the panel is made of glass, it may break or crack if dropped or bumped on hard surface.
- 6) Since CMOS LSI is used in this module, take care of static electricity and insure human earth when handling.
- 7) Do not open nor modify the Module Assembly.
- 8) Do not press the reflector sheet at the back of the module to any directions.
- 9) At the insertion or removal of the Signal Interface Connector, be sure not to rotate nor tilt the Interface Connector of the TFT Module.
- 11)After installation of the TFT Module into an enclosure (Notebook PC Bezel, for example), do not twist nor bend the TFT Module even momentary. At designing the enclosure, it should be taken into consideration that no bending/twisting forces are applied to the TFT Module from outside. Otherwise the TFT Module may be damaged.
- 12) Small amount of materials having no flammability grade is used in the LCD module. The LCD module should be supplied by power complied with requirements of Limited Power Source (IEC60950 or UL1950), or be applied exemption.
- 13) Disconnecting power supply before handling LCD modules, it can prevent electric shock, DO NOT TOUCH the electrode parts, cables, connectors and LED circuit part of TFT module that a LED light bar build in as a light source of back light unit. It can prevent electrostatic breakdown.



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2. General Description

B101EW02 V0 is a Color Active Matrix Liquid Crystal Display composed of a TFT LCD panel, a driver circuit, and LED backlight system. The screen format is intended to support the 1280(H) x 720(V) screen and 262k colors (RGB 6-bits data driver) with LED backlight driving circuit. All input signals are LVDS interface compatible.

B101EW02 V0 is designed for a display unit of notebook style personal computer and industrial machine.

2.1 General Specification

The following items are characteristics summary on the table at 25 $^{\circ}\mathrm{C}$ condition:

Items	Unit	Specifications				
Screen Diagonal	[mm]	255.54(W")				
Active Area	[mm]	222.72(H) X	125.28(V)			
Pixels H x V		1280x3(RGB) x 720			
Pixel Pitch	[mm]	0.1740 (H) x	0.1740 (V)			
Pixel Arrangement		R.G.B. Vertic	al Stripe			
Display Mode		Normally Wh	ite			
White Luminance Note: ILED is LED current	[cd/m ²]	200 typ (Note1)				
Luminance Uniformity (5P)		1.25 max				
Contrast Ratio		500 typ				
Response Time	[ms]	16 typ				
Nominal Input Voltage VDD	[Volt]	+3.3 typ.				
Power Consumption	[Watt]	Тур	Max	Note		
		2.7W	2.9W	Type I , V _{in} =		
		3.1W 3.3W Type I , V _{in} =5V				
Weight	[Grams]	200 max.				
Physical Size	[mm]		L	W	Т	
		Max	235.5	143.5	5.2	
		Typical	235	143.2	-	
		Min	234.5	142.9	-	
Electrical Interface		1 channel LVDS				



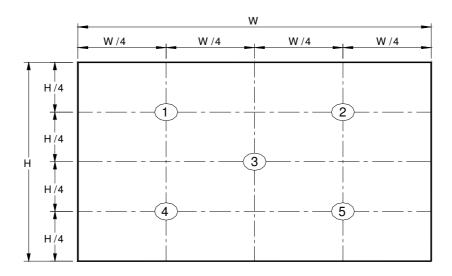
Glass Thickness	[mm]	0.5
Surface Treatment		Glare
Support Color		262K colors (RGB 6-bit)
Temperature Range		
Operating	[°C] [°C]	0 to +50
Storage (Non-Operating)	[°C]	-20 to +60
RoHS Compliance		RoHS Compliance

2.2 Optical Characteristics The optical characteristics are measured under stable conditions at 25 $^{\circ}$ C (Room Temperature) :

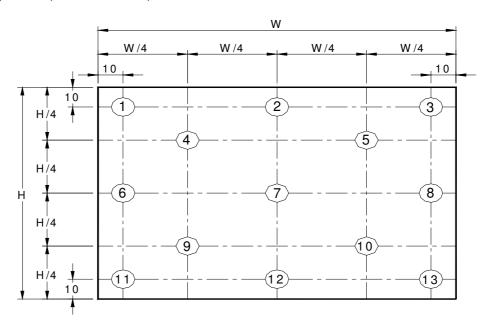
Item		Symbol	Conditions		Min.	Тур.	Max.	Unit	Note
	White Luminance ILED=20mA		5 points average		170	200	-	cd/m ²	1, 4, 5
Viewing Angle		$oldsymbol{ heta}$ R $oldsymbol{ heta}$ L	Horizontal CR = 10	(Right) (Left)	40 40	45 45	- -	degree	4.0
		ф н ф ∟	Vertical CR = 10	(Upper) (Lower)	10 30	15 35	-		4, 9
Luminan Uniformi		δ 5P	5 Poi	ints	-	-	1.25		1, 3, 4
Luminan Uniformi		δ _{13P}	13 Pc	oints	-	-	1.60		2, 3, 4
Contrast R	Contrast Ratio				400	500	-		4, 6
Cross ta	lk	%					4		4, 7
		T_r	Rising		-	12	-		
Response 7	Гime	T_f	Falling		-	4	-	msec	4, 8
		T _{RT}	Rising + Falling		-	16	-		
	Red	Rx			0.549	0.579	0.609		
	Tica	Ry			0.318	0.348	0.378		
Oalan /	Green	Gx			0.306	0.336	0.366		
Color / Chromaticity	GII GGII	Gy			0.524	0.554	0.584		
Coodinates	Blue	Вх	CIE 1	931	0.126	0.156	0.186		4
	Dide	Ву			0.105	0.135	0.165		
	White	Wx			0.283	0.313	0.343		
	Wille	Wy			0.299	0.329	0.359		
NTSC		%			-	45	-		



Note 1: 5 points position (Ref: Active area)



Note 2: 13 points position (Ref: Active area)



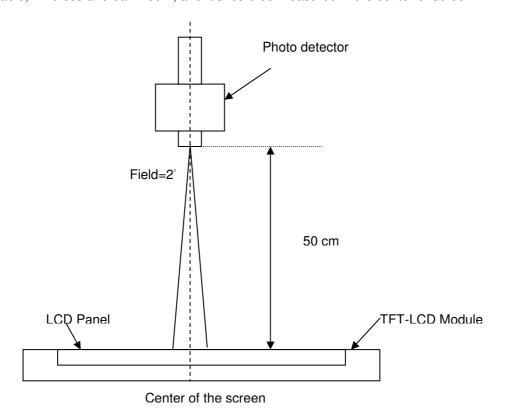
Note 3: The luminance uniformity of 5 or 13 points is defined by dividing the maximum luminance values by the minimum test point luminance

0		Maximum Brightness of five points
δ w5	= -	Minimum Brightness of five points
2	_	Maximum Brightness of thirteen points
δ w13 :	=	Minimum Brightness of thirteen points



Note 4: Measurement method

The LCD module should be stabilized at given temperature for 30 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting Backlight for 30 minutes in a stable, windless and dark room, and it should be measured in the center of screen.



Note 5: Definition of Average Luminance of White (Y_L):

Measure the luminance of gray level 63 at 5 points \cdot $Y_L = [L(1) + L(2) + L(3) + L(4) + L(5)] / 5$ L (x) is corresponding to the luminance of the point X at Figure in Note (1).

Note 6: Definition of contrast ratio:

Contrast ratio is calculated with the following formula.

Brightness on the "White" state Contrast ratio (CR)= Brightness on the "Black" state



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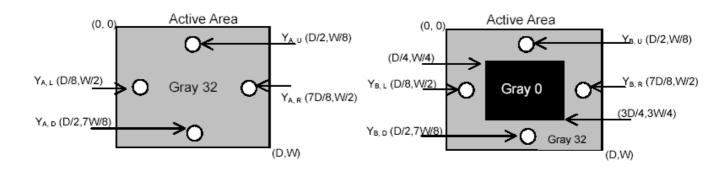
Note 7: Definition of Cross Talk (CT)

 $CT = |Y_B - Y_A| / Y_A \times 100 (\%)$

Where

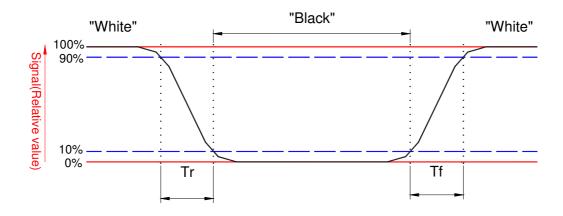
 $Y_A =$ Luminance of measured location without gray level 0 pattern (cd/m₂)

Y_B = Luminance of measured location with gray level 0 pattern (cd/m₂)



Note 8: Definition of response time:

The output signals of BM-7 or equivalent are measured when the input signals are changed from "Black" to "White" (falling time) and from "White" to "Black" (rising time), respectively. The response time interval between the 10% and 90% of amplitudes. Refer to figure as below.

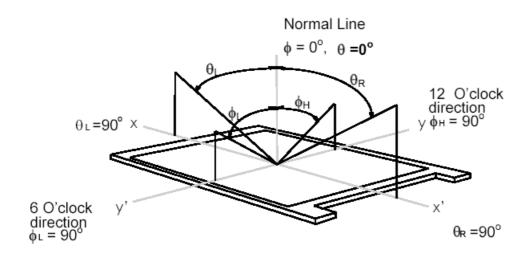




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Note 9. Definition of viewing angle

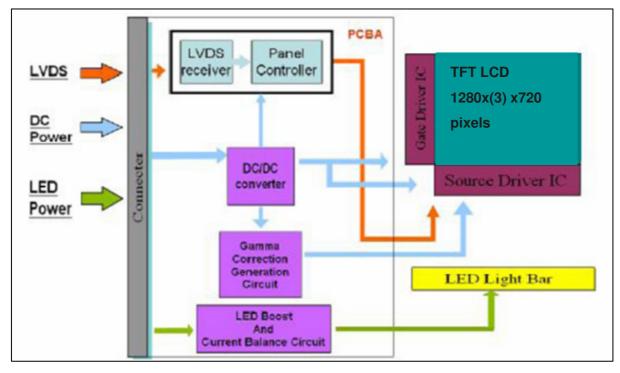
Viewing angle is the measurement of contrast ratio \geq 10, at the screen center, over a 180° horizontal and 180° vertical range (off-normal viewing angles). The 180° viewing angle range is broken down as follows; 90° (θ) horizontal left and right and 90° (Φ) vertical, high (up) and low (down). The measurement direction is typically perpendicular to the display surface with the screen rotated about its center to develop the desired measurement viewing angle.





3. Functional Block Diagram

The following diagram shows the functional block of the 10.1 inches wide Color TFT/LCD 40 Pin (One ch/connector Module:





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4. Absolute Maximum Ratings

An absolute maximum rating of the module is as following:

4.1 Absolute Ratings of TFT LCD Module

Item	Symbol	Min	Max	Unit	Conditions
Logic/LCD Drive Voltage	Vin	-0.3	+4.0	[Volt]	Note 1,2

4.2 Absolute Ratings of Environment

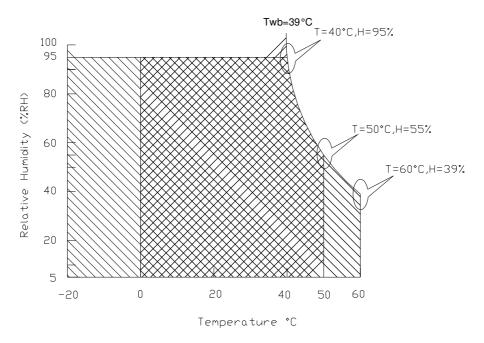
Item	Symbol	Min	Max	Unit	Conditions			
Operating Temperature	TOP	0	+50	[°C]	Note 4			
Operation Humidity	HOP	5	95	[%RH]	Note 4			
Storage Temperature	TST	-20	+60	[°C]	Note 4			
Storage Humidity	HST	5	95	[%RH]	Note 4			

Note 1: At Ta (25°C)

Note 2: Permanent damage to the device may occur if exceed maximum values

Note 3: LED specification refer to section 5.2

Note 4: For quality performance, please refer to AUO IIS (Incoming Inspection Standard).



Operating Range

Storage Range

+



5. Electrical characteristics

5.1 TFT LCD Module

5.1.1 Power Specification

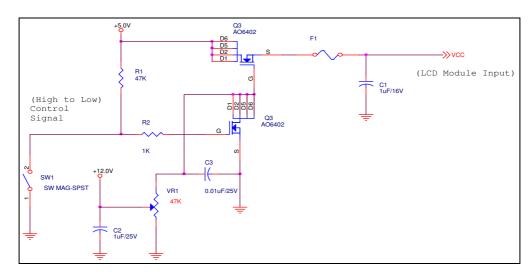
Input power specifications are as follows;

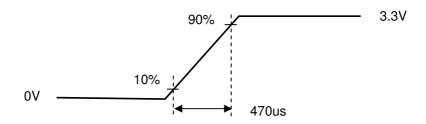
Symble	Parameter	Min	Тур	Max	Unit	Note
VDD	Logic/LCD Drive Voltage	3.0	3.3	3.6	[Volt]	
PDD	VDD Power	_	0.7	0.8	[Watt	Note 1/2
IDD	IDD Current	-	-	250	[mA]	Note 1/2
IRush	Inrush Current	-	-	1500	[mA]	Note 3
VDDrp	Allowable Logic/LCD Drive Ripple Voltage	-	-	100	[mV] p-p	

Note 1: Maximum Measurement Condition: Black Pattern

Note 2: Typical Measurement Condition: Mosaic Pattern

Note 3: Measure Condition





Vin rising time



5.1.2 Signal Electrical Characteristics

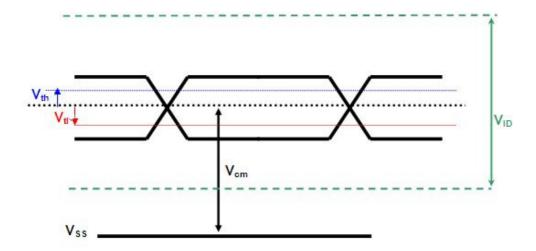
Input signals shall be low or High-impedance state when VDD is off.

It is recommended to refer the specifications of SN75LVDS82DGG (Texas Instruments) in detail.

Signal electrical characteristics are as follows;

Parameter	Condition	Min	Max	Unit
V _{th}	Differential Input High Threshold (Vcm=+1.2V)		100	[mV]
V _{tl}	Differential Input Low Threshold (Vcm=+1.2V)	-100	-	[mV]
V _{ID}	Differential Input Voltage	100	600	[mV]
V _{cm}	Differential Input Common Mode Voltage	1.125	1.375	[V]

Note: LVDS Signal Waveform





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5.2.1 LED characteristics

Parameter	Symbol	Min	Тур	Max	Units	Condition
Backlight Power Consumption	PLED	-	2.0	2.1	[Watt]	(Ta=25°C), Note 1 Type I , V _{in} =12V
Concumption		-	2.4	2.5	[Watt]	(Ta=25°C), Note 1 Type II , V _{in} =5V
LED Life-Time	N/A	12,000	-	-	Hour	(Ta=25°C), Note 2
						I _F =20 mA

Note 1: Calculator value for reference $P_{LED} = VF$ (Normal Distribution) * IF (Normal Distribution) / Efficiency

Note 2: The LED life-time define as the estimated time to 50% degradation of initial luminous

Note 3: This panel will support lower duty ratio at PWM conditional frequency. The PWM frequency constrain between 100 Hz to 300 Hz and a same typical 200Hz. The duty ratio support from 5% to 100%.

5.2.2 Backlight input signal characteristics

Parameter	Symbol	Min	Тур	Max	Units	Remark
LED Dower Cumply	VIED	6.0	12.0	21.0	[Volt]	Type I, Note 1
LED Power Supply	VLED	4.5	5	5.5	[Volt]	Type II, Note 1
LED Enable Input High Level		2.5	-	5.5	[Volt]	
LED Enable Input Low Level	VLED_EN	-	-	0.8	[Volt]	
PWM Logic Input High Level	VPWM_EN	2.5	-	5.5	[Volt]	
PWM Logic Input Low Level		-	-	0.8	[Volt]	
PWM Input Frequency	FPWM	100	-	1K	Hz	
PWM Duty Ratio	Duty	5		100	%	PWM Frequency
PWM Duty Ratio	Duty	15		100	%	PWM Frequency ≥500 Hz

Note 1: Type I and II is an independent of design parameter. It should be separated from system design.



6. Signal Characteristic

6.1 Pixel Format Image

Following figure shows the relationship of the input signals and LCD pixel format.

	1					12	280	
1st Line	R G B	R G B		R	В	R	G	В
							•	
	.		*				•	
	'							
	٠ ا	'	•				•	
	'		·					
720th Line	R G B	R G B		R	В	R	G	В



6.2 The input data format

RxCLKIN	N	
RxIN0	G0 R5 R4 R3 R2 R1 R0	\sim
RxIN1	B1 B0 G5 G4 G3 G2 G1	\rightarrow
RxIN2	DE VS HS B5 B4 B3 B2	\supset

0: :::		
Signal Name	Description	
R5	Red Data 5 (MSB)	Red-pixel Data
R4	Red Data 4	Each red pixel's brightness data consists of
R3	Red Data 3	these 6 bits pixel data.
R2	Red Data 2	
R1	Red Data 1	
R0	Red Data 0 (LSB)	
	, ,	
	Red-pixel Data	
G5	Green Data 5 (MSB)	Green-pixel Data
G4	Green Data 4	Each green pixel's brightness data consists of
G3	Green Data 3	these 6 bits pixel data.
G2	Green Data 2	·
G1	Green Data 1	
G0	Green Data 0 (LSB)	
	,	
	Green-pixel Data	
B5	Blue Data 5 (MSB)	Blue-pixel Data
B4	Blue Data 4	Each blue pixel's brightness data consists of
B3	Blue Data 3	these 6 bits pixel data.
B2	Blue Data 2	
B1	Blue Data 1	
B0	Blue Data 0 (LSB)	
	Blue-pixel Data	
RxCLKIN	Data Clock	The typical frequency is 54.2MHZ.The signal is
		used to strobe the pixel data and DE signals. All
		pixel data shall be valid at the falling edge when
		the DE signal is high.
DE	Display Timing	This signal is strobed at the falling edge of
		RxCLKIN. When the signal is high, the pixel
		data shall be valid to be displayed.
VS	Vertical Sync	The signal is synchronized to RxCLKIN.
HS	Horizontal Sync	The signal is synchronized to RxCLKIN.

Note: Output signals from any system shall be low or High-impedance state when VDD is off.



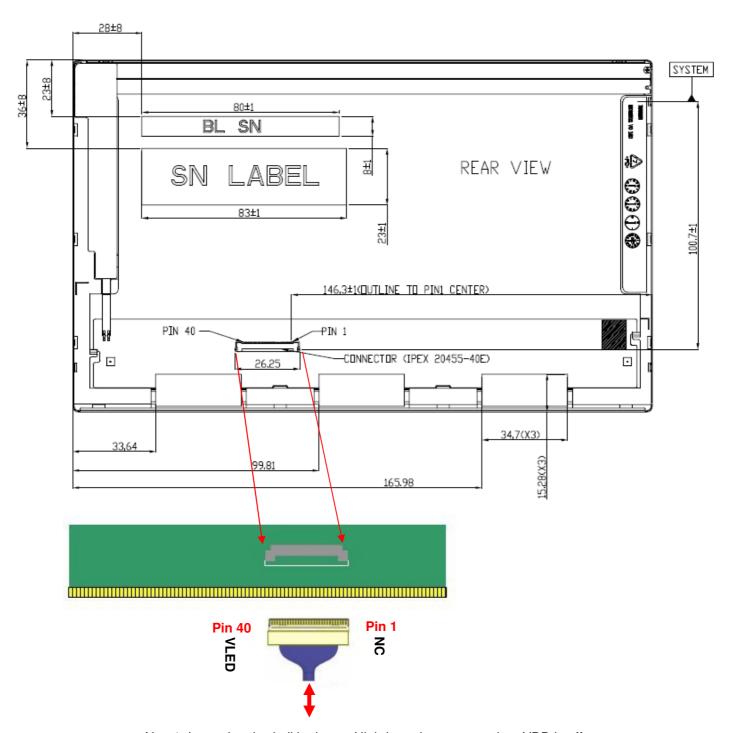
6.3 Signal Description/Pin Assignment

Pin	Signal	Description
1	NC	No Connection (Reserve)
2	AVDD	PowerSupply,3.3V(typical)
3	AVDD	PowerSupply,3.3V(typical)
4	DVDD	DDC 3.3Vpower
5	NC	No Connection (Reserve)
6	SCL	DDCClock
7	SDA	DDCData
8	Rin0-	-LVDSdifferential data input(R0-R5,G0)
9	Rin0+	+LVDSdifferential data input(R0-R5,G0)
10	GND	Ground
11	Rin1-	-LVDSdifferential data input(G1-G5,B0-B1)
12	Rin1+	+LVDSdifferential data input(G1-G5,B0-B1)
13	GND	Ground
14	Rin2-	-LVDSdifferential data input(B2-B5,HS,VS,DE)
15	Rin2+	+LVDSdifferential data input(B2-B5,HS,VS,DE)
16	GND	Ground
17	ClkIN-	-LVDSdifferential clock input
18	ClkIN+	+LVDSdifferential clock input
19	GND	Ground-Shield
20	NC	No Connection (Reserve)
21	NC	No Connection (Reserve)
22	GND	Ground-Shield
23	NC	No Connection (Reserve)
24	NC	No Connection (Reserve)
25	GND	Ground-Shield
26	NC	No Connection (Reserve)
27	NC	No Connection (Reserve)
28	GND	Ground-Shield
29	NC	No Connection (Reserve)
30	NC	No Connection (Reserve)
31	VLED_GND	LED Ground
32	VLED_GND	LED Ground
33	VLED_GND	LED Ground
34	NC	No Connection (Reserve)
35	PWM	System PWM Signal Input
36	LED_EN	LED enable pin(+3.3V Input)
37	NC	No Connection (Reserve)
38	VLED	LED Power Supply 5V~21V
39	VLED	LED Power Supply 5V~21V
40	VLED	LED Power Supply 5V~21V

LVDS is a differential signal technology for LCD interface and high speed data transfer device.



Note1: Start from right side



Note1: Input signals shall be low or High-impedance state when VDD is off.



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6.4 Interface Timing

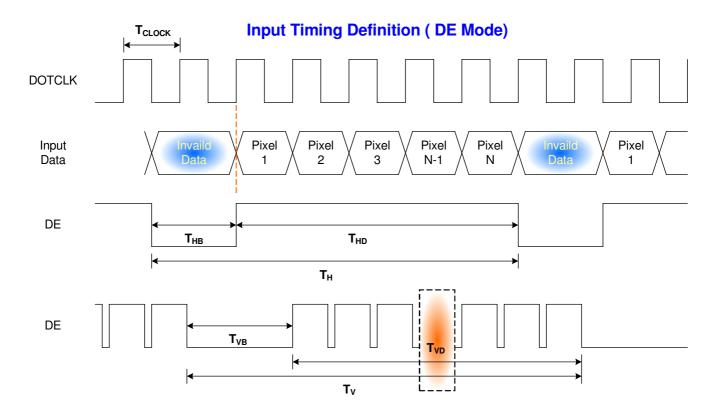
6.4.1 Timing Characteristics

Basically, interface timings should match the 1280 x 720 /60Hz manufacturing guide line timing.

Parameter		Symbol	Min.	Тур.	Max.	Unit
Frame Rate		-		60		Hz
Clock frequency		1/ T _{Clock}	57.2	62.2	90	MHz
	Period	T _V	728	736	1023	
Vertical	Active	T _{VD}	720	720	720	T_{Line}
Section	Blanking	T _{VB}	8	16	303	
	Period	T _H	1310	1408	2047	
Horizontal	Active	T _{HD}	1280	1280	1280	T_{Clock}
Section	Blanking	T _{HB}	30	128	767	

Note: DE mode only

6.4.2 Timing diagram



20 of 29

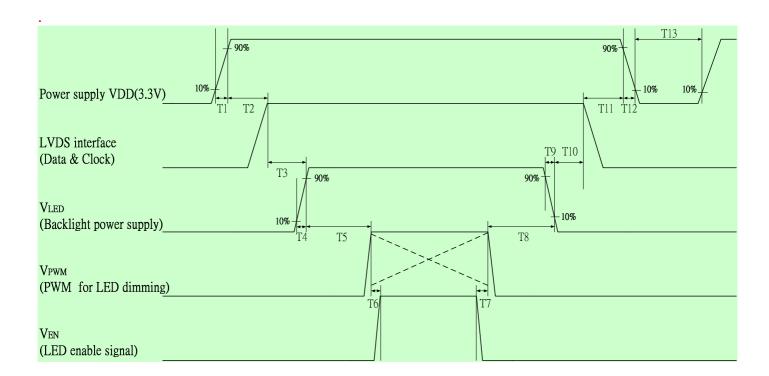


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6.5 Power Sequence

6.5.1 Panel Power Sequence

VDD power and LED on/off sequence is as follows. Interface signals are also shown in the chart. Signals from any system shall be Hi-Z state or low level when VDD is off.



	Pow	er Sequence	Timing	
		Value		
Parameter	Min.(ms)	Typ.(ms)	Max.(ms)	Condition
T1	0.5	-	10	
T2	0	-	50	
Т3	200	-	-	
T4	0.5	-	10	
Т5	10	-	-	
Т6	10	-	-	
Т7	0	-	-	
Т8	10		200	VLED=6~21V(Type I)
10	10	-	-	VLED=5V(type II)
Т9	0	-	10	
T10	200	-	-	
T11	0.5	-	50	
T12	0	-	10	
T13	400	-	-	



7. Panel Reliability Test

7.1 Vibration Test

Test Spec:

Test method: Non-Operation

Acceleration: 1.5 G

Frequency: 10 - 500Hz Random

Sweep: 30 Minutes each Axis (X, Y, Z)

7.2 Shock Test

Test Spec:

Test method: Non-Operation

Acceleration: 220 G, Half sine wave

Active time: 2 ms

Pulse: X,Y,Z .one time for each side

7.3 Reliability Test

Items	Required Condition	Note
Temperature Humidity Bias	Ta= 40℃, 90%RH, 300h	
High Temperature Operation	Ta= 50℃, Dry, 300h	
Low Temperature Operation	Ta= 0℃, 300h	
High Temperature Storage	Ta= 60℃, 35%RH, 300h	
Low Temperature Storage	Ta= -20℃, 50%RH, 250h	
Thermal Shock Test	Ta=-20℃to 60℃, Duration at 30 min, 100 cycles	
ESD	Contact : ±8 KV	Note 1
LSD	Air: ±15 KV	

Note1: According to EN 61000-4-2, ESD class B: Some performance degradation allowed. No data lost

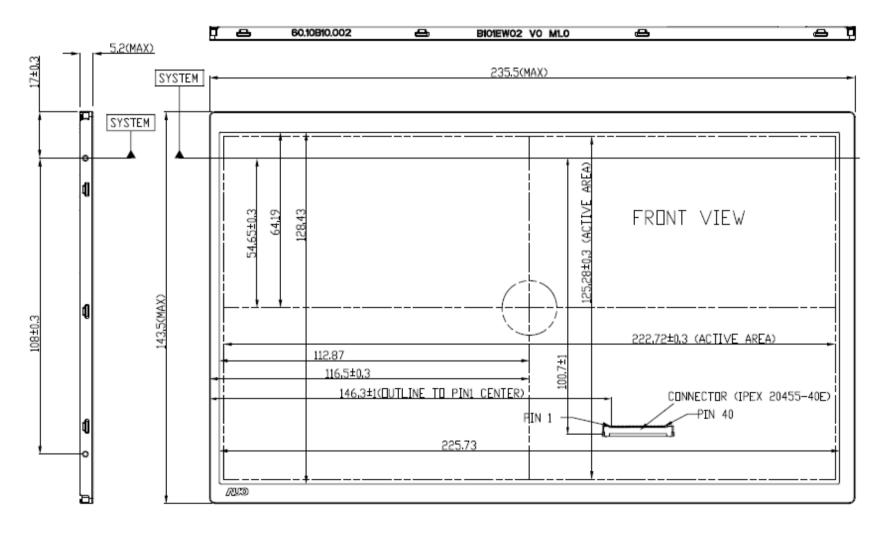
. Self-recoverable. No hardware failures.

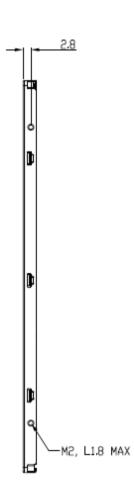
Remark: MTBF (Excluding the LED): 30,000 hours with a confidence level 90%.



8. Mechanical Characteristics

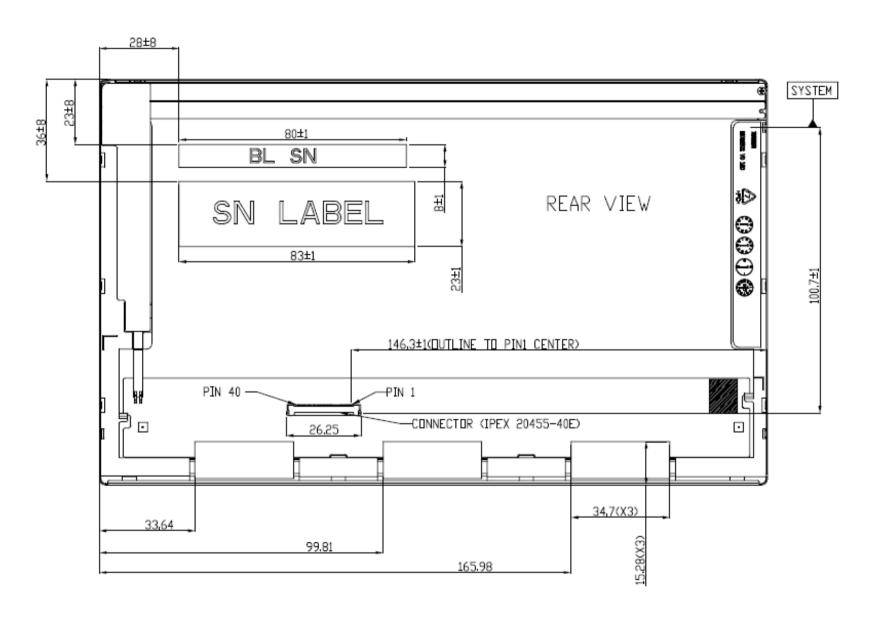
8.1 LCM Outline Dimension







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9. Shipping and Package

9.1 Shipping Label Format



Manufactured 09/06 Model No: B101EW02 V0 **AU Optronics** MADÉ IN China (S1)

H/W: 1A F/W:1

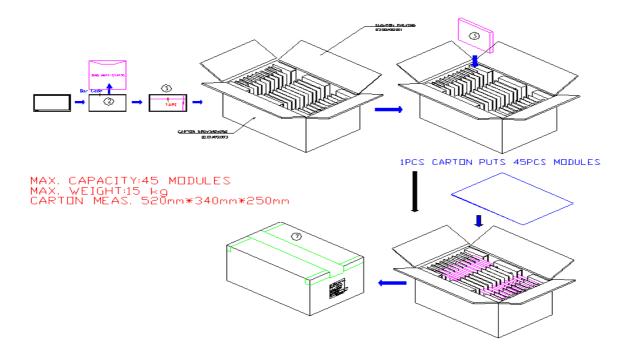


* H/W code control table :

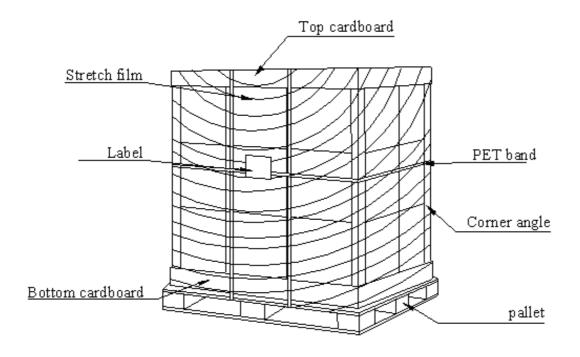
IC	Combination	Control Code	H/W
Source	Radium	1AXXG	1.0
Gate	Radium	IAAAG	1A



9.2 Carton package



9.3 Shipping package of palletizing sequence



B101EW02 V0 document version : 1.0 26 of 29



10. Appendix: EDID description

B101EW02 V0 EDID Code

Address	FUNCTION	Value	Value	Valu
HEX		HEX	BIN	DEC
00	Header	00	00000000	0
01		FF	11111111	255
02		FF	11111111	255
03		FF	11111111	255
04		FF	11111111	255
05		FF	11111111	255
06		FF	11111111	255
07		00	00000000	0
08	EISA Manuf. Code LSB	06	00000110	6
09	Compressed ASCII	AF	10101111	175
0A	Product Code	D5	11010101	213
0B	hex, LSB first	20	00100000	32
0C	32-bit ser #	00	00000000	0
0D		00	00000000	0
0E		00	00000000	0
0F		00	00000000	0
10	Week of manufacture	01	00000001	1
11	Year of manufacture	13	00010011	19
12	EDID Structure Ver.	01	00000001	1
13	EDID revision #	03	00000011	3
14	Video input def. (digital I/P, non-TMDS, CRGB)	80	10000000	128
15	Max H image size (rounded to cm)	16	00010110	22
16	Max V image size (rounded to cm)	0D	00001101	13
17	Display Gamma (=(gamma*100)-100)	78	01111000	120
18	Feature support (no DPMS, Active OFF, RGB, tmg Blk#1)	0A	00001010	10
19	Red/green low bits (Lower 2:2:2:2 bits)	43	01000011	67
1A	Blue/white low bits (Lower 2:2:2:2 bits)	25	00100101	37
1B	Red x (Upper 8 bits)	94	10010100	148
1C	Red y/ highER 8 bits	59	01011001	89
1D	Green x	56	01010110	86
1E	Green y	8D	10001101	141
1F	Blue x	28	00101000	40
20	Blue y	22	00100010	34
21	White x	50	01010000	80
22	White y	54	01010100	84
23	Established timing 1	00	00000000	0
24	Established timing 2	00	00000000	0
25	Established timing 3	00	00000000	0
26	Standard timing #1	01	00000001	1
27		01	00000001	1
28	Standard timing #2	01	00000001	1



		1		1
29		01	00000001	1
2A	Standard timing #3	01	00000001	1
2B		01	00000001	1
2C	Standard timing #4	01	00000001	1
2D		01	00000001	1
2E	Standard timing #5	01	00000001	1
2F		01	00000001	1
30	Standard timing #6	01	00000001	1
31		01	00000001	1
32	Standard timing #7	01	00000001	1
33		01	00000001	1
34	Standard timing #8	01	00000001	1
35		01	00000001	1
36	Pixel Clock/10000 LSB	06	00000110	6
37	Pixel Clock/10000 USB	18	00011000	24
38	Horz active Lower 8bits	00	00000000	0
39	Horz blanking Lower 8bits	70	01110000	112
3A	HorzAct:HorzBlnk Upper 4:4 bits	50	01010000	80
3B	Vertical Active Lower 8bits	D0	11010000	208
3C	Vertical Blanking Lower 8bits	10	00010000	16
3D	Vert Act : Vertical Blanking (upper 4:4 bit)	20	00100000	32
3E	HorzSync. Offset	30	00110000	48
3F	HorzSync.Width	20	00100000	32
40	VertSync.Offset : VertSync.Width	36	00110110	54
41	Horz‖ Sync Offset/Width Upper 2bits	00	00000000	0
42	Horizontal Image Size Lower 8bits	DE	11011110	222
43	Vertical Image Size Lower 8bits	7D	01111101	125
44	Horizontal & Vertical Image Size (upper 4:4 bits)	00	00000000	0
45	Horizontal Border (zero for internal LCD)	00	00000000	0
46	Vertical Border (zero for internal LCD)	00	00000000	0
47	Signal (non-intr, norm, no stero, sep sync, neg pol)	18	00011000	24
48	Detailed timing/monitor	00	00000000	0
49	descriptor #2	00	00000000	0
4A		00	00000000	0
4B		0F	00001111	15
4C		00	00000000	0
4D		00	00000000	0
4E		00	00000000	0
4F		00	00000000	0
50		00	00000000	0
51		00	00000000	0
52		00	00000000	0
53		00	00000000	0
54		00	00000000	0
55		00	00000000	0
56		00	00000000	0
57		00	00000000	0

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58		00	00000000	0
59		20	00100000	32
5A	Detailed timing/monitor	00	00000000	0
5B	descriptor #3	00	00000000	0
5C	•	00	00000000	0
5D		FE	11111110	254
5E		00	00000000	0
5F	Manufacture	41	01000001	65
60	Manufacture	55	01010101	85
61	Manufacture	4F	01001111	79
62		0A	00001010	10
63		20	00100000	32
64		20	00100000	32
65		20	00100000	32
66		20	00100000	32
67		20	00100000	32
68		20	00100000	32
69		20	00100000	32
6A		20	00100000	32
6B		20	00100000	32
6C	Detailed timing/monitor	00	00000000	0
6D	descriptor #4	00	00000000	0
6E		00	00000000	0
6F		FE	11111110	254
70		00	00000000	0
71	Manufacture P/N	42	01000010	66
72	Manufacture P/N	31	00110001	49
73	Manufacture P/N	30	00110000	48
74	Manufacture P/N	31	00110001	49
75	Manufacture P/N	45	01000101	69
76	Manufacture P/N	57	01010111	87
77	Manufacture P/N	30	00110000	48
78	Manufacture P/N	32	00110010	50
79	Manufacture P/N	20	00100000	32
7 A	Manufacture P/N	56	01010110	86
7B	Manufacture P/N	30	00110000	48
7C		20	00100000	32
7D		0A	00001010	10
7E	Extension Flag	00	00000000	0
7F	Checksum	36	00110110	54